DECEMBER 1983-REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

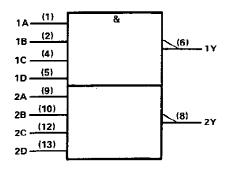
These devices contain two independent 4-input NAND gates.

The SN5420, SN54LS20, and SN54S20 are characterized for operation over the full military range of $-55\,^{\circ}\text{C}$ to 125 $^{\circ}\text{C}$. The SN7420, SN74LS20, and SN74S20 are characterized for operation from 0 $^{\circ}\text{C}$ to 70 $^{\circ}\text{C}$.

FUNCTION TABLE (each gate)

	INP	UTS		QUTPUT
Α	В	С	D	Y
н	Н	Н	Н	Ļ
L	х	Х	х	Н
x	L	X	x	Н
х	Х	L.	×	н
х	X	Х	L	н

logic symbol[†]



[†]This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

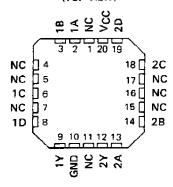
SN5420 . . . J PACKAGE
SN54LS20, SN54S20 . . . J OR W PACKAGE
SN7420 . . . N PACKAGE
SN74LS20, SN74S20 . . . D OR N PACKAGE
(TOP VIEW)

	_	_	1 1		L_	
1A	Ц	1	\cup	14	Ц	Vcc
1B	◁	2		13		2D
NC	□	3		12		2C
1 C	□	4		11		NC
1 D	₫	5		10		2B
1Y	d	6		9		2A
GND	d	7		8		2Y

SN5420 . . . W PACKAGE (TOP VIEW)

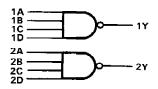
1A	ī	U 14	þ	1 D
1Y	2	13		1C
NC	3	12	Þ	1 B
/cc	4	11	Þ	GND
NC	5	10	Þ	2Y
2A	6	9	Þ	2D
2B	7	8	Þ	2C

SN54L\$20, SN54S20 . . . FK PACKAGE (TOP VIEW)



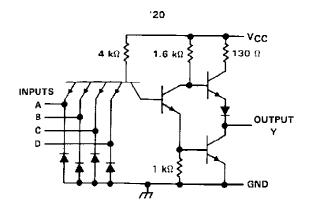
NC - No internal connection

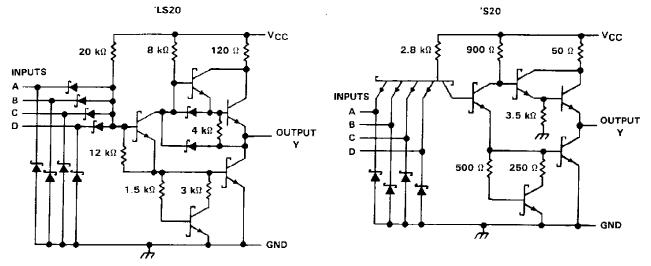
logic diagram



positive logic Y = $\overline{A \cdot B \cdot C \cdot D}$ or Y = \overline{A} + \overline{B} + \overline{C} + \overline{D}

schematics (each gate)





Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)		7 V
Input voltage: '20, 'S20		5.5 V
'LS20		7 V
Operating free-air temperature range:	SN54'	55°C to 125°C
	SN74'	0°C to 70°C
Storage temperature range		65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminals.



recommended operating conditions

			SN5420			SN7420		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	٧
VIH	High-level input voltage	2			2			٧
VIL	Low-level input voltage			0.8			8.0	ν
lон	High-level output current			 0.4			- 0.4	mΑ
loL	Low-level output current			16			16	MΑ
TA	Operating free-air temperature	- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

				SN5420			SN742	0	UNIT
PARAMETER		TEST CONDITIONS T			MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} = MIN,	I _j = - 12 mA		-	– 1.5			1.5	٧
Voн	V _{CC} = MIN,	V _{IL} = 0.8 V, I _{OH} = - 0.4 mA	2.4	3.4		2.4	3.4		٧
VoL	VCC = MIN,	V _{IH} = 2 V, l _{OL} = 16 mA		0.2	0.4		0.2	0.4	٧
l _l	V _{CC} - MAX,	V ₁ - 5.5 V			1		_	1	mΑ
ΊΗ	V _{CC} = MAX,	V ₁ = 2.4 V			40			40	μΑ
1 ₁ L	V _{CC} = MAX,	V ₁ = 0.4 V			- 1.6			- 1.6	mA
los§	V _{CC} = MAX		- 20		- 55	_ 18		- 55	mA
іссн	V _{CC} = MAX,	V = 0 V		2	4		2	4	mA
ICCL.	V _{CC} = MAX,	V ₁ = 4.5 V		6	11		6	11	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at V_{CC} = 5 V, T_{A} = 25°C. § Not more than one output should be shorted at a time.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	IDITIONS	MIN	TYP	мах	UNIT
[†] PLH	A	V	2 400 0	0 45 5		12	22	ns
ŧРНL	Any	Y	R _L = 400 Ω,	CL = 15 pF		8	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

SN54LS20, SN74LS20 DUAL 4-INPUT POSITIVE-NAND GATES

recommended operating conditions

		SN54LS20			SN74LS20			
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
VCC Supply voltage	4.5	5	5.5	4.75	5	5.25	٧	
V _{IH} High-level input voltage	2			2			٧	
V _{IL} Low-level input voltage			0.7			0.8	V	
IOH High-level output current			- 0.4			- 0.4	mΑ	
IOL Low-level output current			4			8	mΑ	
TA Operating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

BA DAMACTED	i	TEST CONDITIONS T			SN54LS	20		SN74LS	20	LINIT
PARAMETER		1257 557/51116115				MAX	MIN	TYP\$	MAX	UNIT
Vik	VCC = MIN,	i = – 18 mA				- 1.5			– 1.5	V
v _{он}	V _{CC} = MIN,	VIL = MAX,	I _{OH} = - 0.4 mA	2.5	3,4		2.7	3.4		v
	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OL} = 4 mA		0.25	0.4			0.4	
VOL	V _{CC} = MIN,	V _{IH} = 2 V,	10L = 8 mA					0.25	0.5	' '
11	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mΑ
liн	V _{CC} = MAX,	V ₁ = 2.7 V				20			20	μА
IIL	V _{CC} = MAX,	V! = 0.4 V				- 0.4			- 0.4	mΑ
IOS §	V _{CC} = MAX		<u> </u>	- 20		- 100	- 20		- 100	mA
Іссн	V _{CC} = MAX,	V = 0 V			0.4	0.8		0.4	8.0	mA
CCL	V _{CC} = MAX,	V ₁ = 4.5 V			1.2	2.2		1.2	2.2	mA

¹ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, VCC = 5 V, TA = 25°C (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS			TYP	MAX	UNIT
tPLH .	Апу	>	$R_1 = 2 k\Omega$,	C _I = 15 pF		9	15	ns
[‡] PHL	Ally	<u>.</u>	11 - 2 Kaz,	CL - 19 PF		10	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_{\Delta} = 25^{\circ}\text{C}$.

[§] Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

recommended operating conditions

			SN54S20			SN74S20			
		MIN	NOM	MAX	MIN	NOM	MAX	TINU	
V _{CC} Sup	ply voltage	4.5	5	5.5	4.75	5	5.25	V	
V _{IH} Hig	h-level input voltage	2			2	·		٧	
VIL Lov	v-level input voltage			8.0			0.8	V	
OH High	h-level output current			- 1			- 1	mΑ	
IOL LOV	v-level output current			20			20	mΑ	
Тд Оре	rating free-air temperature	- 55		125	0		70	°c	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

0.000.000	TEST CONDITIONS †	SN54S20	SN74S20	UNIT
PARAMETER	TEST CONDITIONS	MIN TYP# MAX	MIN TYP‡ MAX	UNIT
Vik	V _{CC} = MIN, I _f = -18 mA	-1.2	-1.2	٧
∨он	V _{CC} = MIN, V _{IL} = 0.8 V, I _{OH} = 1 mA	2.5 3.4	2.7 3.4	٧
Vol	V _{CC} = MIN, V _{1H} = 2 V, I _{OL} = 20 mA	0.5	0.5	٧
I _I	V _{CC} = MAX, V ₁ = 5.5 V	1	1	mА
IIH	V _{CC} = MAX, V _I = 2.7 V	50	50	μΑ
կ <u>լ</u>	V _{CC} = MAX, V _I = 0.5 V	-2	2	mΑ
los§	V _{CC} = MAX	-40 -100	-40 -100	mA
¹ ссн	V _{CC} = MAX, V _I = 0 V	5 8	5 8	mA
ICCL	V _{CC} = MAX, V _I = 4.5 V	10 18	10 18	mA

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	TYP	МАХ	UNIT	
tpLH			R _L = 280 Ω,	C _L = 15 pF		3	4.5	п\$
tPHL	A B C B	, l		ο <u>Γ</u> - 19 μι		3	5	ns,
tpLH	A, B, C or D	Ť	$R_1 = 280 \Omega$,	C = 50 = 5		4.5		ns
^t PHL			n 200 12,	C _L = 50 pF		5		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$. § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
JM38510/07006BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BCA	Samples
JM38510/07006BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BDA	Samples
JM38510/07006BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BDA	Samples
JM38510/30007B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007B2A	Samples
JM38510/30007B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007B2A	Samples
JM38510/30007BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BCA	Samples
JM38510/30007BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BCA	Samples
JM38510/30007BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BDA	Samples
JM38510/30007BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BDA	Samples
M38510/07006BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BCA	Samples
M38510/07006BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BCA	Samples
M38510/07006BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BDA	Samples
M38510/07006BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 07006BDA	Samples
M38510/30007B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007B2A	Samples
M38510/30007B2A	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007B2A	Samples
M38510/30007BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BCA	Samples





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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
M38510/30007BCA	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BCA	Samples
M38510/30007BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BDA	Samples
M38510/30007BDA	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30007BDA	Samples
SN54LS20J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS20J	Samples
SN54LS20J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS20J	Samples
SN54S20J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S20J	Samples
SN54S20J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S20J	Samples
SN74LS20D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS20	Samples
SN74LS20D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS20	Samples
SN74LS20DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS20	Samples
SN74LS20DR	ACTIVE	SOIC	D	14	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS20	Samples
SN74LS20N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS20N	Samples
SN74LS20N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS20N	Samples
SN74LS20NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS20N	Samples
SN74LS20NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS20N	Samples
SN74LS20NSR	ACTIVE	SO	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS20	Samples
SN74LS20NSR	ACTIVE	so	NS	14	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS20	Samples
SN74S20D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S20	Samples
SN74S20D	ACTIVE	SOIC	D	14	50	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S20	Samples
SN74S20N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S20N	Samples



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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74S20N	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S20N	Samples
SN74S20NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S20N	Samples
SN74S20NE4	ACTIVE	PDIP	N	14	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S20N	Samples
SNJ54LS20FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 20FK	Samples
SNJ54LS20FK	ACTIVE	LCCC	FK	20	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS 20FK	Samples
SNJ54LS20J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS20J	Samples
SNJ54LS20J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS20J	Samples
SNJ54LS20W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS20W	Samples
SNJ54LS20W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54LS20W	Samples
SNJ54S20J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S20J	Samples
SNJ54S20J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S20J	Samples
SNJ54S20W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S20W	Samples
SNJ54S20W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54S20W	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

PACKAGE OPTION ADDENDUM

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Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54LS20, SN54S20, SN74LS20, SN74S20:

Catalog: SN74LS20, SN74S20

Military: SN54LS20, SN54S20

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS20DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS20NSR	so	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
SN74LS20DR	SOIC	D	14	2500	356.0	356.0	35.0	
SN74LS20NSR	SO	NS	14	2000	356.0	356.0	35.0	



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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
JM38510/07006BDA	W	CFP	14	1	506.98	26.16	6220	NA
JM38510/30007B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
JM38510/30007BDA	W	CFP	14	1	506.98	26.16	6220	NA
M38510/07006BDA	W	CFP	14	1	506.98	26.16	6220	NA
M38510/30007B2A	FK	LCCC	20	1	506.98	12.06	2030	NA
M38510/30007BDA	W	CFP	14	1	506.98	26.16	6220	NA
SN74LS20D	D	SOIC	14	50	506.6	8	3940	4.32
SN74LS20N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS20N	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS20NE4	N	PDIP	14	25	506	13.97	11230	4.32
SN74LS20NE4	N	PDIP	14	25	506	13.97	11230	4.32
SN74S20D	D	SOIC	14	50	506.6	8	3940	4.32
SN74S20N	N	PDIP	14	25	506	13.97	11230	4.32
SN74S20N	N	PDIP	14	25	506	13.97	11230	4.32
SN74S20NE4	N	PDIP	14	25	506	13.97	11230	4.32
SN74S20NE4	N	PDIP	14	25	506	13.97	11230	4.32
SNJ54LS20FK	FK	LCCC	20	1	506.98	12.06	2030	NA
SNJ54LS20W	W	CFP	14	1	506.98	26.16	6220	NA

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



CERAMIC DUAL IN LINE PACKAGE



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G





CERAMIC DUAL IN LINE PACKAGE



- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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